



## Product Change Notification / BLAS-13QXRP379

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**Date:**

16-May-2024

**Product Category:**

Computing Embedded Controllers

**PCN Type:**

Manufacturing Change

**Notification Subject:**

CCB 7010 Initial Notice: Qualification of ATP7 as an additional assembly site for MEC1723N-B0-I/LJ, MEC1723N-B0-I/LJ-TR, MEC1723N-LOP-I/LJ, MEC1723N-LOP-I/LJ-TR, MEC1723N-P1-I/LJ and MEC1723N-P2-I/LJ catalog part numbers (CPN) available in 176L WFBGA (10x10x0.8mm) package.

**Affected CPNs:**

[BLAS-13QXRP379\\_Affected\\_CPN\\_05162024.pdf](#)  
[BLAS-13QXRP379\\_Affected\\_CPN\\_05162024.csv](#)

**Notification Text:**

**PCN Status:**Initial Notification

**PCN Type:**Manufacturing Change

**Microchip Parts Affected:**Please open one of the files found in the Affected CPNs section.  
Note: For your convenience Microchip includes identical files in two formats (.pdf and .xls)

**Description of Change:**Qualification of ATP7 as an additional assembly site for MEC1723N-B0-I/LJ, MEC1723N-B0-I/LJ-TR, MEC1723N-LOP-I/LJ, MEC1723N-LOP-I/LJ-TR, MEC1723N-P1-I/LJ and MEC1723N-P2-I/LJ catalog part numbers (CPN) available in 176L WFBGA (10x10x0.8mm) package.

**Pre and Post Change Summary:**

	Pre Change		Post Change		
Assembly Site	ASE Inc. (ASE)	Amkor Assembly & Test (Shanghai) Co., LTD  (ANAC)	ASE Inc. (ASE)	Amkor Assembly & Test (Shanghai) Co., LTD  (ANAC)	Amkor Technology Philippines (P3/P4), INC. (ATP7)
Substrate Core Material	CCL-HL832NS	HL832NXA	CCL-HL832NS	HL832NXA	HL832NXA
Substrate SM Material	PSR4000 AUS308	AUS320	PSR4000 AUS308	AUS320	AUS320
Wire Material	CuPd	CuPdAu	CuPd	CuPdAu	CuPdAu
Die Attach 1 Material	ATB-125	HR-9004	ATB-125	HR-9004	EM-760L2-P
Die Attach 2 Material	FH-SC13-HR510 4	HR-9004	FH-SC13-HR51 04	HR-9004	EM-760L2-P
Molding Compound Material	KE-G1250NAS	G750E	KE-G1250NAS	G750E	G770FE

**Impacts to Data Sheet:**None

**Change Impact:**None

**Reason for Change:**To improve on-time delivery performance by qualifying ATP7 as an additional assembly site.

**Change Implementation Status:**In Progress

**Estimated Qualification Completion Date:**October 2024

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

**Time Table Summary:**

	May 2023					>	October 2024				
Workweek	1 8	1 9	2 0	2 1	2 2		4 0	4 1	4 2	4 3	4 4
Initial PCN Issue Date			X								
Qual Report Availability							X				
Final PCN Issue Date							X				

**Method to Identify Change:**Traceability code

**Qualification Plan:**Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Plan.

**Revision History:**May 16, 2024: Issued initial notification.

## Attachments:

[PCN\\_BLAS-13QXRP379 Qual Plan.pdf](#)

Please contact your local **Microchip sales office** with questions or concerns regarding this notification.

## Terms and Conditions:

If you wish to receive Microchip PCNs via email please register for our PCN email service at our **PCN home page** select register then fill in the required fields. You will find instructions about registering for Microchips PCN email service in the **PCN FAQ** section.

If you wish to change your PCN profile, including opt out, please go to the **PCN home page** select login and sign into your myMicrochip account. Select a profile option from the left navigation bar and make the applicable selections.